

SCA/HPCAsia 2026

Everything with HPC - AI, Cloud, QC and Future Society

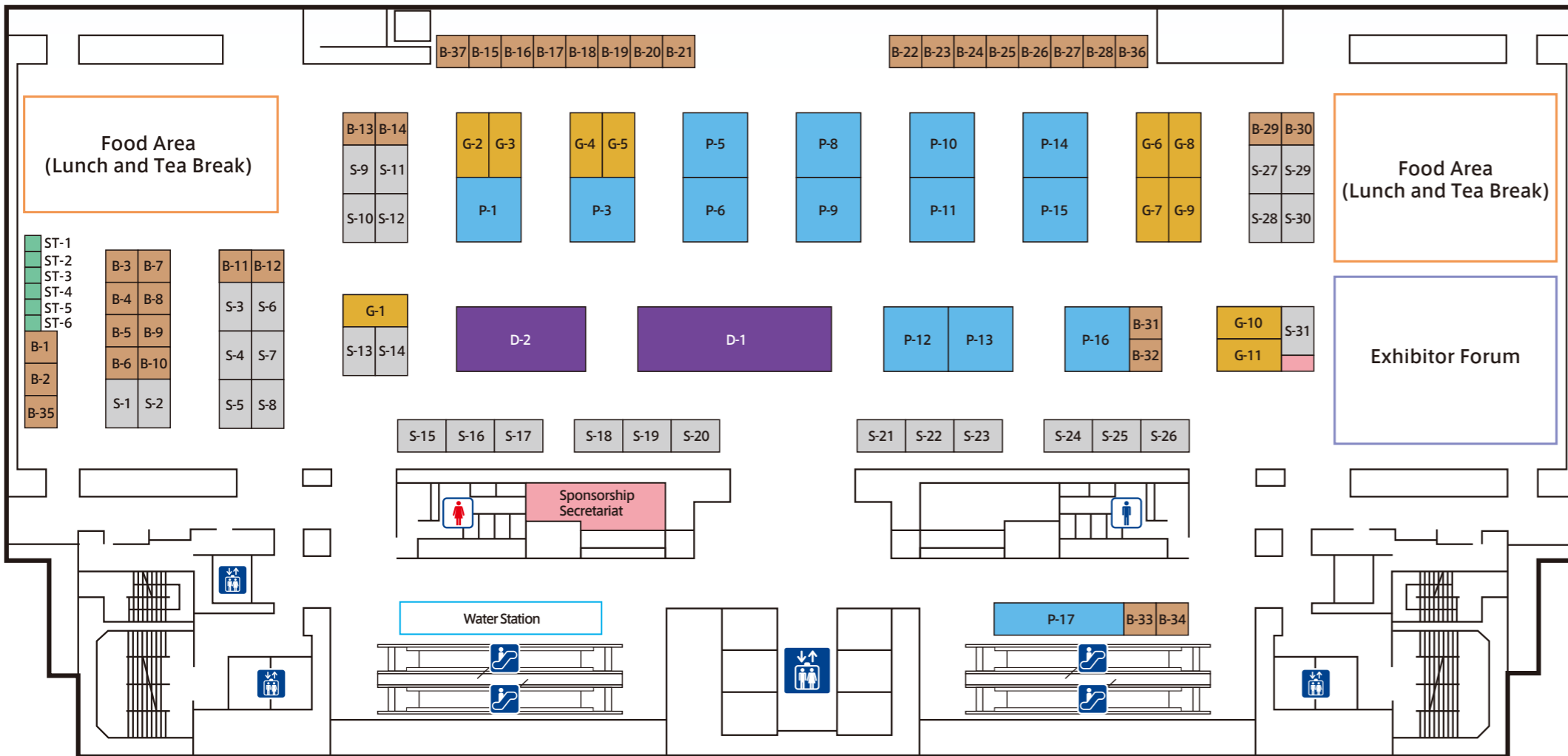


Date **January 26-29, 2026**

Venue **Osaka International Convention Center (Osaka, Japan)**

EXHIBITION: January 27-29, 2026

Event Hall, 3rd Floor



■ DIAMOND
 ■ PLATINUM
 ■ GOLD
 ■ SILVER
 ■ BRONZE
 ■ START-UP
 ■ SCA/HPCAsia

◇ Host Organization
 SupercomputingAsia 2026
 The International Conference on High Performance Computing in Asia-Pacific Region 2026
 ◇ Secretariat of SCA/HPCAsia 2026
 c/o Convention Linkage, Inc.
 11F PIAS TOWER, 3-19-3 Toyosaki, Kita-ku, Osaka-city, Osaka 531-0072, Japan
 E-mail: sca_hpcasia_2026@c-linkage.co.jp

<https://www.sca-hpcasia2026.jp/>



[All Floor] SSID: FREE-OICC
PASS: grandcube

[3F] SSID: SCAHPCAsia2026_3F
PASS: sca_2026

[10F] SSID: SCAHPCAsia2026_10F
PASS: hpca_2026

Exhibitors and Sponsors

DIAMOND

- D-1 GMO Internet, Inc.
- D-2 Hewlett Packard Enterprise

PLATINUM

- P-1 Vertiv
- P-3 Lenovo
- P-5 Mitsubishi Heavy Industries, Ltd.
- P-6 CORE MICRO SYSTEMS INC.
- P-8 Google Cloud Japan G.K.
- P-9 Amazon Web Services
- P-10 Fujitsu Limited
- P-11 IBM Japan, Ltd.
- P-12 DataDirect Networks
- P-13 Quantinuum
- P-14 nVent Japan/Kawamura Electric Inc
- P-15 NEC Corporation
- P-16 NSCC Singapore
- P-17 RIKEN R-CCS
- NVIDIA G.K.

GOLD

- G-1 VAST Data
- G-2 NetApp G.K.
- G-3 Super Micro Computer, Inc.
- G-4 IQM Quantum Computers
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- G-9 CSC - IT Center for Science / LUMI Supercomputer
- G-10 WEKA
- G-11 ASUS JAPAN INC.
- S-31 AMD Japan Ltd.

SILVER

- S-1 University of Hyogo
- S-2 Okinawa Institute of Science and Technology
- S-3 TOMEN DEVICES CORPORATION
- S-4 Cerebras
- S-5 TOKYO ELECTRON DEVICE LTD.
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- S-7 Fixstars Corporation
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- S-14 Sakura Internet Inc.
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- S-26 Slurm
- S-27 National Center for High-performance Computing (NCHC)
- S-28 Advanced Industrial Science and Technology
- S-29 Digital Research Alliance of Canada
- S-30 Research Organization for Information Science and Technology

BRONZE

- B-1 PC Cluster Consortium
- B-2 DATALIVE Corporation
- B-3 Kyushu University
- B-4 Center for Computational Sciences, University of Tsukuba
- B-5 JHPCN (Joint Usage/Research Center for Interdisciplinary Large-scale Information Infrastructures)
- B-6 Information Technology Center, The University of Tokyo
- B-7 National Institute of Informatics
- B-8 Tohoku University
- B-9 Hokkaido University Information Initiative Center
- B-10 Institute of Science Tokyo
- B-11 ClusterVision Solutions
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- B-30 Australia's HPC
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- B-32 VSTECs (SINGAPORE) PTE LTD
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- B-34 RIKEN R-CCS
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- B-36 Classiq Technologies
- B-37 VDURA, Inc.
- CosaWell Corporation

START-UP

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- ST-2 Morgenrot Inc.
- ST-3 HPC Gridware
- ST-4 Open OnDemand
- ST-5 Qunova Computing Inc.
- ST-6 X-ScaleSolutions
- PASQAL